L Number	Hits	Search Text	DB	Time stamp
2	162	345/1.3.ccls.	USPAT;	2004/09/20 16:59
			US-PGPUB	
1	47	345/1.2.ccls.	USPAT;	2004/09/20 17:17
			US-PGPUB	
3 ·	383	345/1.1.ccls.	USPAT;	2004/09/20 17:17
		•	US-PGPUB	
4	146	display adj substrate same (electronic adj (module or component)	USPAT;	2004/09/20 17:37
		or (circuit adj chip) or (integrated adj circuit))	US-PGPUB	
5	4	(display adj substrate same (electronic adj (module or component)	USPAT;	2004/09/20 17:34
		or (circuit adj chip) or (integrated adj circuit))) and tile\$	US-PGPUB	
6	40	display adj substrate same (electronic adj (module or component)	EPO; JPO;	2004/09/20 17:44
		or (circuit adj chip) or (integrated adj circuit))	DERWENT	
7	10408	substrate near3 recess	USPAT;	2004/09/20 17:44
			US-PGPUB;	
1			EPO; JPO;	
			DERWENT	
8	2	display adj substrate near3 recess	USPAT;	2004/09/20 17:45
			US-PGPUB;	
			EPO; JPO;	
i		•	DERWENT	
9 j	2	(display adj substrate) near3 recess	USPAT;	2004/09/20 17:46
	•		US-PGPUB;	
			EPO; JPO;	
_			DERWENT	
10	283	(substrate near3 recess) same display	USPAT;	2004/09/20 17:47
1			US-PGPUB;	
			EPO; JPO;	
			DERWENT	
11	89	(substrate near3 recess) near6 display	USPAT;	2004/09/20 17:47
		·	US-PGPUB;	
			EPO; JPO;	
L			DERWENT	<u> </u>